

Amendments to the Specification:

Please replace the title as follows:

~~CIRCUIT BOARD, METHOD OF MANUFACTURING THE SAME, AND TRANSFER~~
~~CHIP HAVING A PLURALITY OF FIRST PAD ELECTRODES CONNECTED TO~~
~~WIRING METHOD OF MANUFACTURING CIRCUIT BOARD INCLUDING~~
~~TRANSFER CHIP HAVING A PLURALITY OF FIRST PAD ELECTRODES~~
~~CONNECTED TO WIRING~~